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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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H7N1004FN

Silicon N-Channel MOSFET High-Speed Power Switching

REJ03G1593-0100

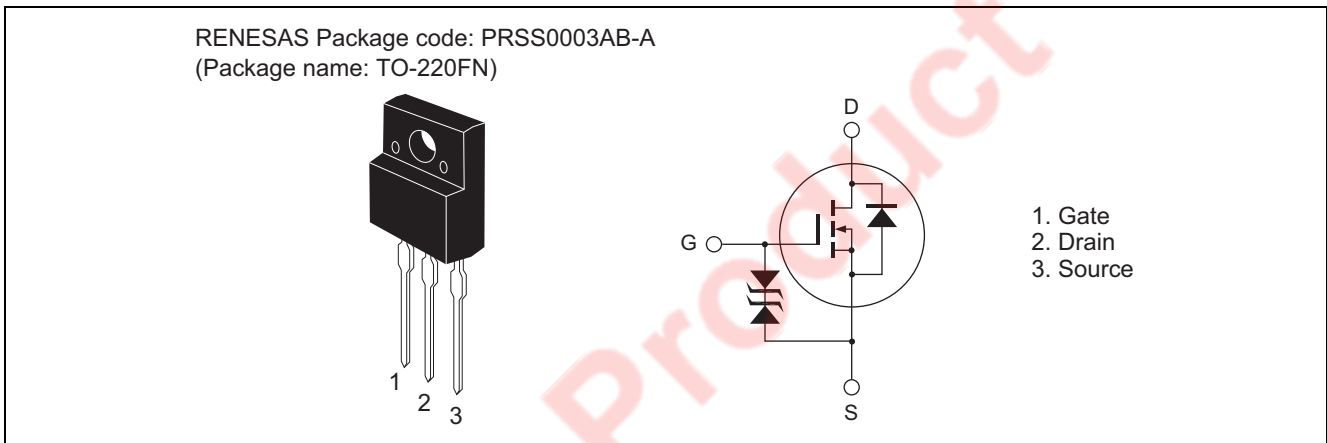
Rev.1.00

Oct 23, 2007

Features

- Low on-resistance
- $R_{DS(on)} = 25 \text{ m}\Omega$ typ.
- Low drive current
- Available for 4.5 V gate drive

Outline



Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Value	Unit
Drain to source voltage	V_{DSS}	100	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	25	A
Drain peak current	I_D (pulse) ^{Note 1}	100	A
Body-drain diode reverse drain current	I_{DR}	25	A
Avalanche current	I_{AP} ^{Note 3}	15	A
Avalanche energy	E_{AR} ^{Note 3}	22.5	mJ
Channel dissipation	P_{ch} ^{Note 2}	25	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$

2. Value at $T_c = 25^\circ\text{C}$

3. Value at $T_{ch} = 25^\circ\text{C}$, $R_g \geq 50 \Omega$

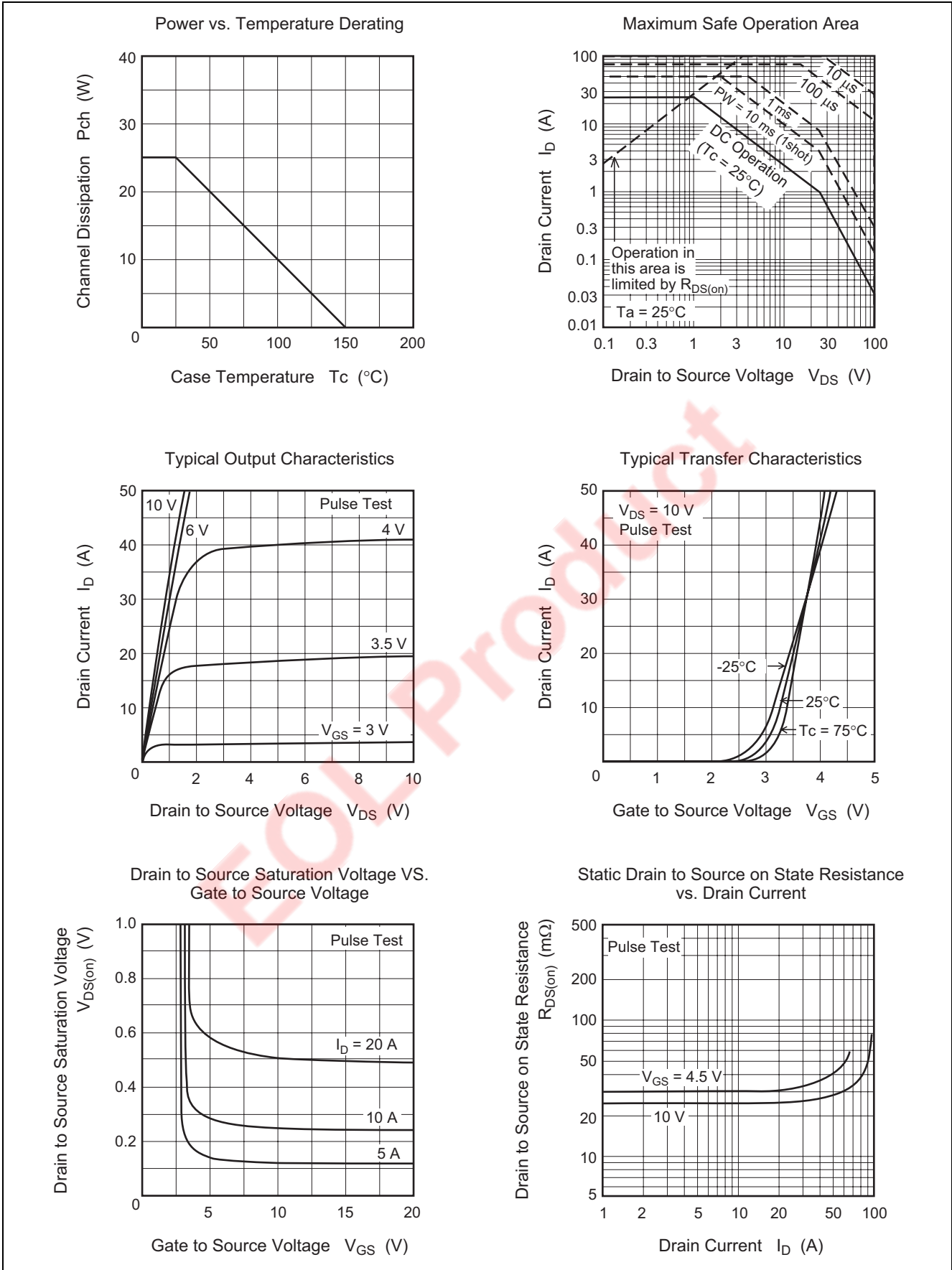
Electrical Characteristics

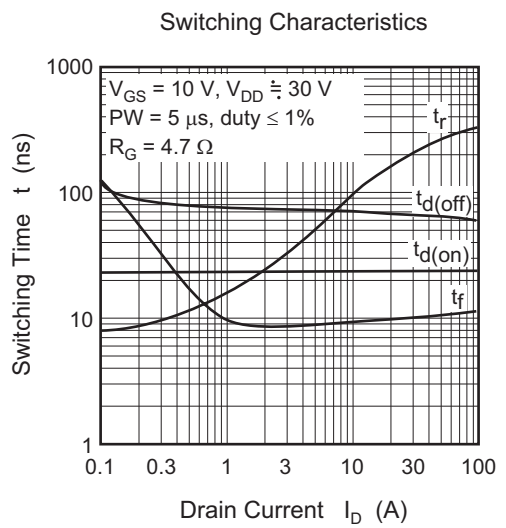
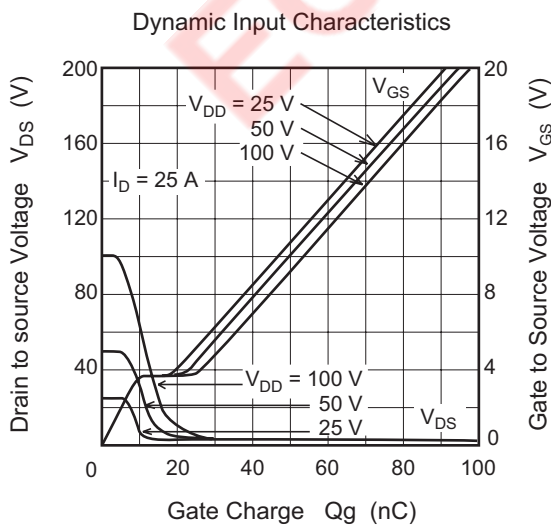
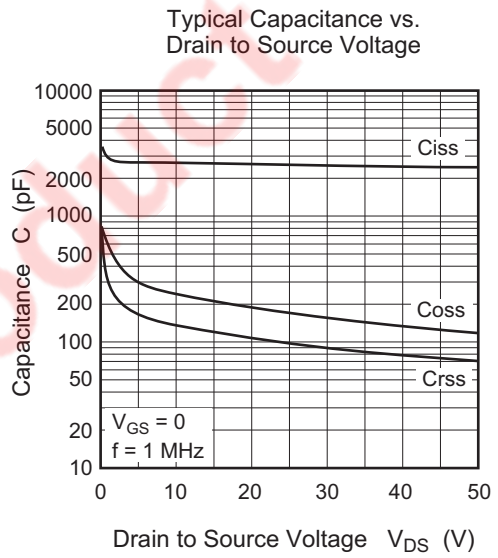
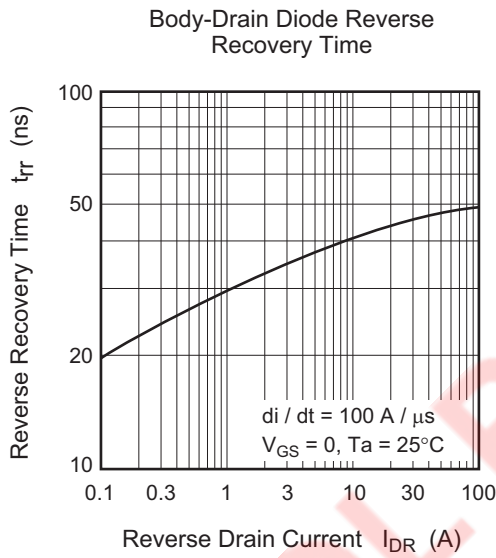
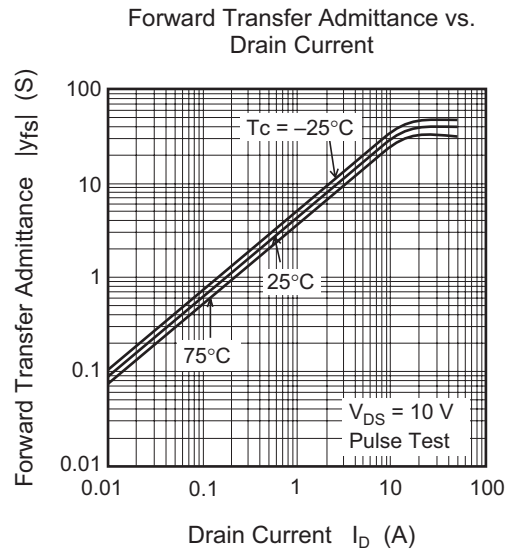
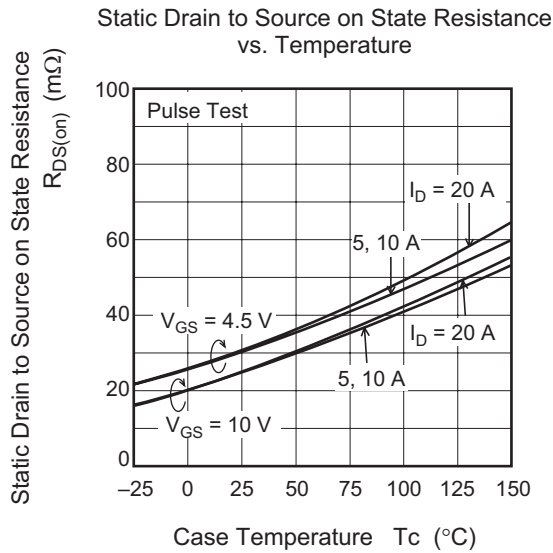
(Ta = 25°C)

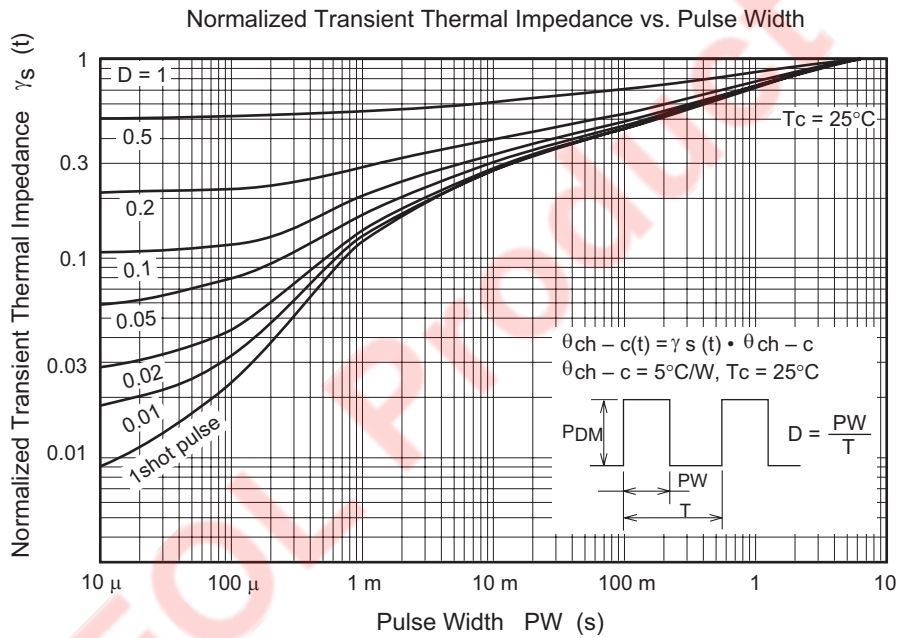
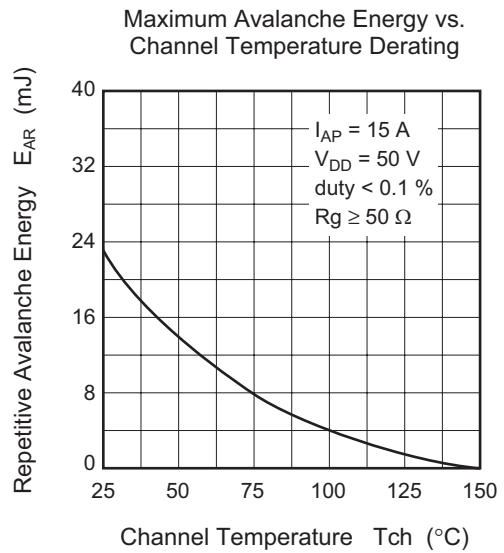
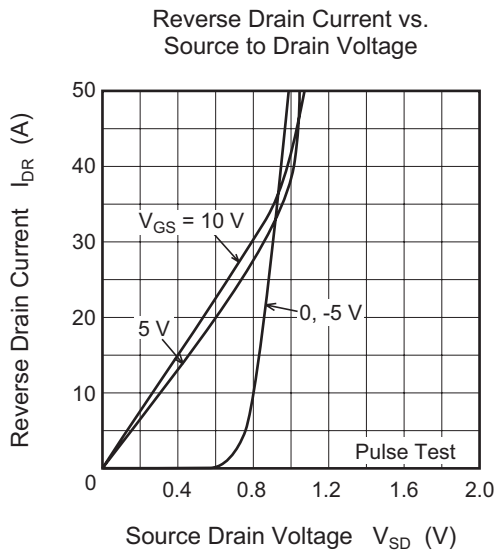
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	100	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 100 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.5	—	2.5	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$ ^{Note 4}
Static drain to source on state resistance	$R_{DS(on)}$	—	25	35	$\text{m}\Omega$	$I_D = 12.5 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note 4}
		—	30	45	$\text{m}\Omega$	$I_D = 12.5 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note 4}
Forward transfer admittance	$ y_{fs} $	20	35	—	S	$I_D = 12.5 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note 4}
Input capacitance	C_{iss}	—	2800	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	240	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	140	—	pF	$f = 1 \text{ MHz}$
Total gate charge	Q_g	—	50	—	nC	$V_{DD} = 50 \text{ V}$
Gate to source charge	Q_{gs}	—	9	—	nC	$V_{GS} = 10 \text{ V}$
Gate to drain charge	Q_{gd}	—	11	—	nC	$I_D = 25 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	23	—	ns	$V_{GS} = 10 \text{ V}$, $I_D = 12.5 \text{ A}$
Rise time	t_r	—	110	—	ns	$R_L = 2.4 \text{ }\Omega$
Turn-off delay time	$t_{d(off)}$	—	70	—	ns	$R_g = 4.7 \text{ }\Omega$
Fall time	t_f	—	9.5	—	ns	
Body-drain diode forward voltage	V_{DF}	—	0.89	—	V	$I_F = 25 \text{ A}$, $V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	45	—	ns	$I_F = 25 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse test

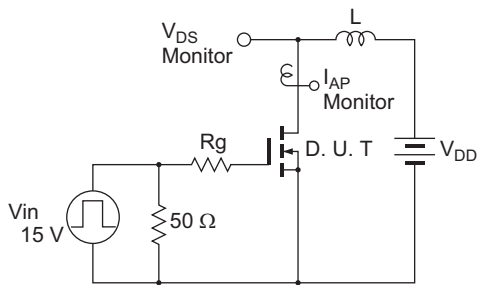
Main Characteristics





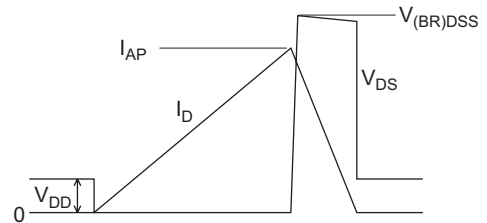


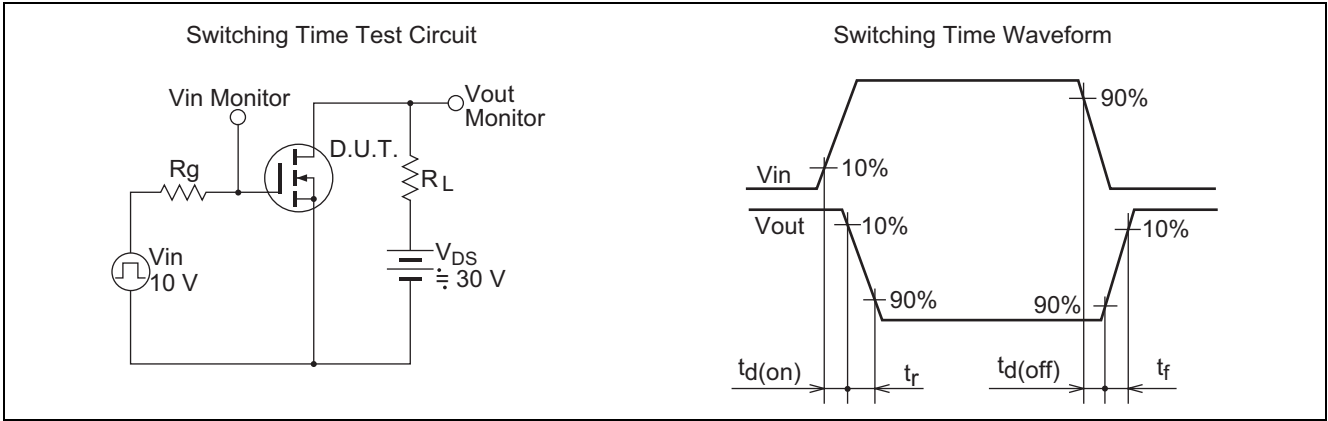
Avalanche Test Circuit



Avalanche Waveform

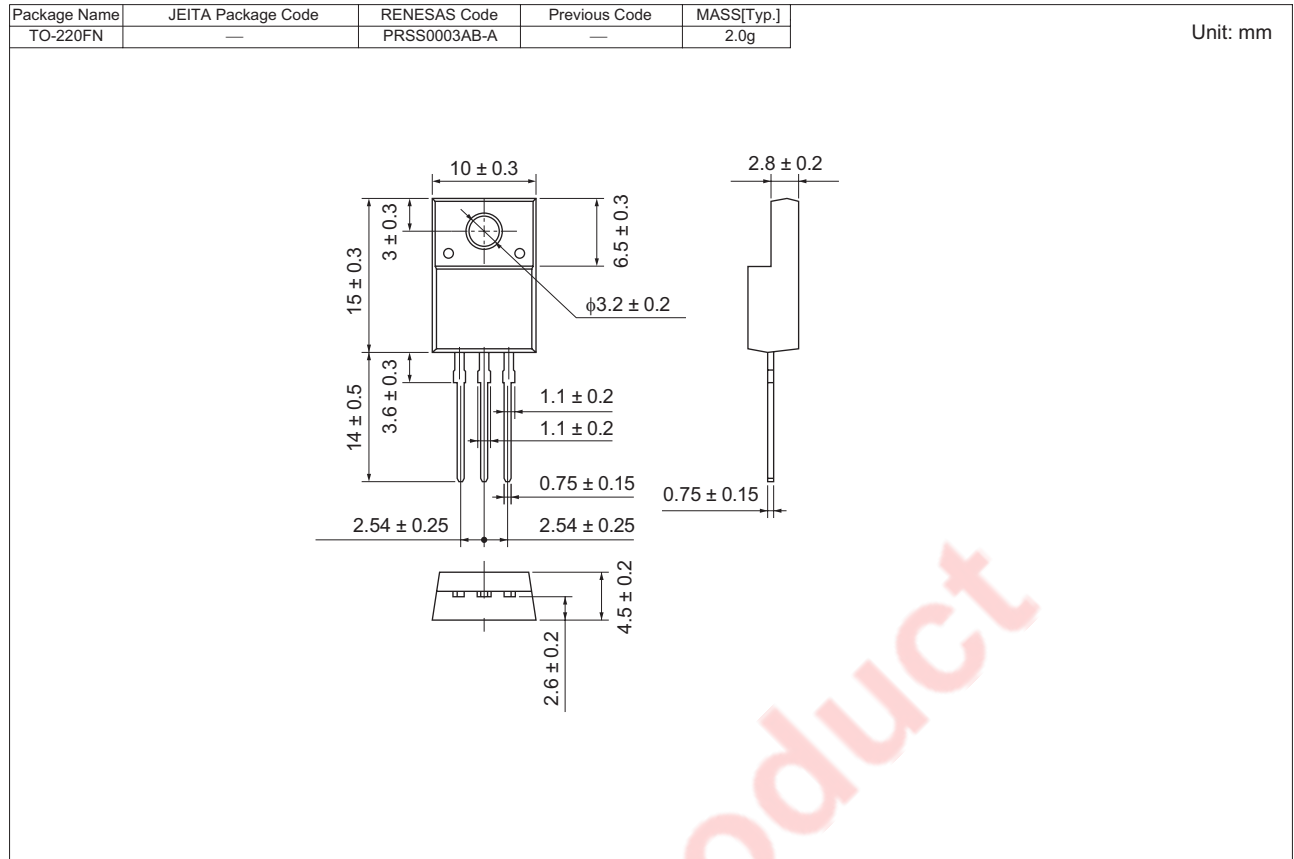
$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$





EOL Product

Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
H7N1004FN	50 pcs	Plastic Magazine (Tube)

Notes:

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